

Module 2

Problem #1

The mobility of free electrons and holes in pure germanium are 3800 and 1800 cm²/V-s respectively. The corresponding values for pure silicon are 1300 and 500 cm²/V-s, respectively. Determine the values of intrinsic conductivity for both germanium and silicon. Assume $n_i = 2.5 \times 10^{13} \text{ cm}^{-3}$ for germanium and $n_i = 1.5 \times 10^{10} \text{ cm}^{-3}$ for silicon at room temperature.

Solution (i) The intrinsic conductivity for germanium,

$$\begin{aligned}\sigma_i &= qn_i(\mu_n + \mu_p) \\ &= (1.602 \times 10^{-19}) (2.5 \times 10^{13}) (3800 + 1800) \\ &= 0.0224 \text{ S/cm}\end{aligned}$$

(ii) The intrinsic conductivity for silicon,

$$\begin{aligned}\sigma_i &= qn_i(\mu_n + \mu_p) \\ &= (1.602 \times 10^{-19}) (1.5 \times 10^{10}) (1300 + 500) \\ &= 4.32 \times 10^{-6} \text{ S/cm}\end{aligned}$$

Problem #2

In an N-type semiconductor, the Fermi level is 0.3 eV below the conduction level at a room temperature of 300 K. If the temperature is increased to 360 K, determine the new position of the Fermi level.

Solution The Fermi level in an N-type material is given by

$$E_F = E_C - kT \ln \frac{N_C}{N_D}$$

Therefore,

$$(E_C - E_F) = kT \ln \frac{N_C}{N_D}$$

At $T = 300$ K,

$$0.3 = 300 k \ln \frac{N_C}{N_D}$$

Similarly,

$$E_C - E_{F1} = 360 k \ln \frac{N_C}{N_D}$$

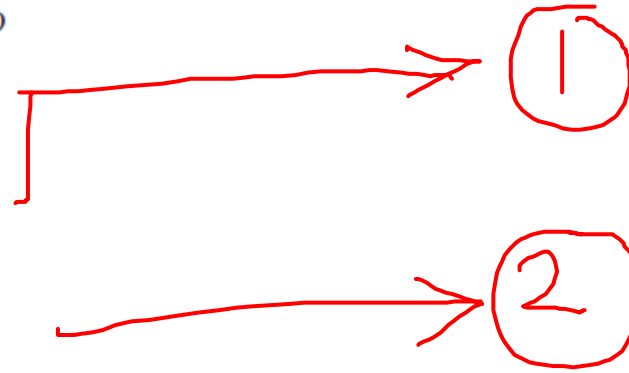
Equation (2) divided by Eq. (1) gives

$$\frac{E_C - E_{F1}}{0.3} = \frac{360}{300}$$

Therefore,

$$E_C - E_{F1} = \frac{360}{300} \times 0.3 = 0.36 \text{ eV}$$

Hence, the new position of the Fermi level lies 0.36 eV below the conduction level.



Problem #3

In a P-type semiconductor, the Fermi level lies 0.4 eV above the valence band. Determine the new position of Fermi level if the concentration of acceptor atoms is multiplied by a factor of (a) 0.5 and (b) 4. Assume $kT = 0.025$ eV.

Solution In a P-type material, the concentration of acceptor atoms is given by

$$N_A = N_V e^{-(E_F - E_V)/kT}$$

Let initially $N_A = N_{AO}$, $E_F = E_{FO}$ and $E_{FO} - E_V = 0.4$ eV

Therefore, $N_{AO} = N_V e^{-0.4/0.025} = N_V e^{-16}$

(a) When $N_A = 0.5$, N_{AO} and $E_F = E_{F1}$, then

$$0.5N_{AO} = N_V e^{-(E_{F1} - E_V)/0.025} = N_V e^{-40(E_{F1} - E_V)}$$

Therefore, $0.5 \times N_V e^{-16} = N_V e^{-40(E_{F1} - E_V)}$

Therefore, $0.5 = e^{-40(E_{F1} - E_V) + 16}$

Taking natural logarithm on both sides, we get

$$\ln(0.5) = -40(E_{F1} - E_V) + 16$$

Therefore, $E_{F1} - E_V = 0.417$ eV

(b) When $N_A = 4N_{AO}$ and $E_F = E_{F2}$, then

$$\ln 4 = -40(E_{F2} - E_V) + 16$$

Therefore, $E_{F2} - E_V = 0.365 \text{ eV}$

Problem #4 (Law of Mass Action)

Consider a silicon PN junction at $T = 300 \text{ K}$ so that $n_i = 1.5 \times 10^{10} \text{ cm}^{-3}$. The N-type doping is $1 \times 10^{10} \text{ cm}^{-3}$ and a forward bias of 0.6 V is applied to the PN junction. Calculate the minority hole concentration at the edge of the space charge region.

Solution Given $T = 300 \text{ K}$, $n_i = 1.5 \times 10^{10} \text{ cm}^{-3}$, $n \approx 1 \times 10^{10} \text{ cm}^{-3}$ and $V_F = 0.6 \text{ V}$.

Mass Action law

$$n \cdot p = n_i^2$$

Therefore, the concentration of holes, $p = \frac{n_i^2}{n}$

$$= \frac{(1.5 \times 10^{10})^2}{1 \times 10^{10}} = 2.25 \times 10^{10} \text{ cm}^{-3}$$

Problem #5 (Law of Mass Action)

Find the concentration (densities) of holes and electrons in N-type silicon at 300 K, if the conductivity is 300 S/cm. Also find these values for P-type silicon. Given that for Silicon at 300 K, $n_i = 1.5 \times 10^{10}/\text{cm}^3$, $\mu_n = 1300 \text{ cm}^2/\text{V-s}$ and $\mu_p = 500 \text{ cm}^2/\text{V-s}$.

Solution (a) Concentration in N-type silicon

The conductivity of an N-type silicon is $\sigma = qn\mu_n$

Concentration of electrons,
$$n = \frac{\sigma}{q\mu_n} = \frac{300}{(1.602 \times 10^{-19})(1300)} = 1.442 \times 10^{18} \text{ cm}^{-3}$$

Hence concentration of holes,
$$p = \frac{n_i^2}{n} = \frac{(1.5 \times 10^{10})^2}{1.442 \times 10^{18}} = 1.56 \times 10^2 \text{ cm}^{-3}$$

(b) Concentration in *P*-type silicon

The conductivity of a *P*-type silicon is $\sigma = qp\mu_p$

Hence, concentration of holes $p = \frac{\sigma}{q\mu_p}$

$$= \frac{300}{(1.602 \times 10^{-19})(500)} = 3.75 \times 10^{18} \text{ cm}^{-3}$$

and concentration of electrons, $n = \frac{n_i^2}{p} = \frac{(1.5 \times 10^{10})^2}{3.75 \times 10^{18}} = 0.6 \times 10^2 \text{ cm}^{-3}$

Problem #6

A sample of silicon at a given temperature T in intrinsic condition has a resistivity of $25 \times 10^4 \Omega\text{-cm}$. The sample is now doped to the extent of 4×10^{10} donor atoms/ cm^3 and 10^{10} acceptor atoms/ cm^3 . Find the total conduction current density if an electric field of 4 V/cm is applied across the sample. Given that $\mu_n = 1250 \text{ cm}^2/\text{V-s}$, $\mu_p = 475 \text{ cm}^2/\text{V-s}$ at the given temperature.

Solution

$$\sigma_i = qn_i(\mu_n + \mu_p) = \frac{1}{25 \times 10^4}$$

Therefore,

$$\begin{aligned} n_i &= \frac{\sigma_i}{q(\mu_n + \mu_p)} = \frac{1}{(25 \times 10^4) (1.602 \times 10^{-19}) (1250 + 475)} \\ &= 1.45 \times 10^{10} \text{ cm}^{-3} \end{aligned}$$

Net donor density

$$N_D (= n) = (4 \times 10^{10} - 10^{10}) = 3 \times 10^{10} \text{ cm}^{-3}$$

Hence,

$$p = \frac{n_i^2}{N_D} = \frac{(1.45 \times 10^{10})^2}{3 \times 10^{10}} = 0.7 \times 10^{10} \text{ cm}^{-3}$$

Hence,

$$\begin{aligned}\sigma &= q(n\mu_n + p\mu_p) \\ &= (1.602 \times 10^{-19}) (3 \times 10^{10} \times 1250 + 0.7 \times 10^{10} \times 475) \\ &= 6.532 \times 10^{-6} \text{ S/cm}\end{aligned}$$

Therefore, total conduction current density,

$$J = \sigma E = 6.532 \times 10^{-6} \times 4 = 26.128 \times 10^{-6} \text{ A/cm}^2$$